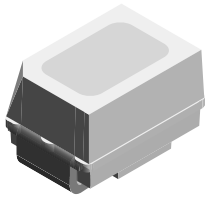
MiniLED Ultrabright

Description

The new MiniLED Series have been designed in a small white SMT package. The feature of the device is the very small package 2.3 mm x 1.3 mm x 1.4 mm. The MiniLED is an obvious solution for small-scale, high-power products that are expected to work reliability in an arduous environment. This is often the case in automotive and industrial application.



Features

- SMD LEDs with exceptional brightness
- Luminous intensity categorized
- Compatible with automatic placement equipment
- IR reflow soldering
- Available in 8 mm tape
- Low profile package
- Non-diffused lens: Excellent for coupling to light pipes and backlighting
- Low power consumption
- Luminous intensity ratio in one packing unit $I_{Vmax}/I_{Vmin} \leq 2.0$, optional ≤ 1.6
- Lead-free device

Applications

- Automotive: Backlighting in dashboards and switches
- Telecommunication: Indicator and backlighting in telephone and fax
- Indicator and backlight for audio and video equipment
- Indicator and backlight in office equipment
- Flat backlight for LCDs, switches and symbols

Parts Table

Part	Color, Luminous Intensity	Angle of Half Intensity (±φ)	Technology
VLMK2300-GS08	Red, I_V = 90 mcd (typ.)	60°	AlInGaP on GaAs
VLMF2300-GS08	Orange, I_V = 112 mcd (typ.)	60°	AlInGaP on GaAs
VLME2300-GS08	Yellow, I_V = 112 mcd (typ.)	60°	AlInGaP on GaAs

Absolute Maximum Ratings

T_{amb} = 25 °C, unless otherwise specified
VLMK230. ,VLMF230. ,VLME230.

Parameter	Test condition	Symbol	Value	Unit
Reverse voltage		V_R	5	V
DC Forward current	$T_{amb} \leq 80$ °C	I_F	30	mA
Surge forward current	$t_p \leq 10$ µs	I_{FSM}	0.1	A
Power dissipation	$T_{amb} \leq 80$ °C	P_V	80	mW
Junction temperature		T_j	125	°C
Operating temperature range		T_{amb}	- 40 to + 100	°C

Parameter	Test condition	Symbol	Value	Unit
Storage temperature range		T_{stg}	- 40 to + 100	°C
Soldering temperature	according to IPC 9501	T_{sd}	245	°C
Thermal resistance junction/ ambient	mounted on PC board (pad size > 5 mm^2)	R_{thJA}	580	K/W

Optical and Electrical Characteristics

T_{amb} = 25 °C, unless otherwise specified

Red

VLMK230.

Parameter	Test condition	Symbol	Min	Typ.	Max	Unit
Luminous intensity [1]	I_F = 20 mA	I_V	35.5	90		mcd
Dominant wavelength	I_F = 20 mA	λ_d		630		nm
Peak wavelength	I_F = 20 mA	λ_p		643		nm
Angle of half intensity	I_F = 20 mA	φ		± 60		deg
Forward voltage	I_F = 20 mA	V_F		1.9	2.6	V
Reverse voltage	I_R = 10 µA	V_R	5			V
Junction capacitance	V_R = 0, f = 1 MHz	C_j		15		pF

[1] in one Packing Unit $I_{Vmax}/I_{Vmin} \leq 2.0$

Orange

VLMF230.

Parameter	Test condition	Symbol	Min	Typ.	Max	Unit
Luminous intensity [1]	I_F = 20 mA	I_V	56	112		mcd
Dominant wavelength	I_F = 20 mA	λ_d	598	605	611	nm
Peak wavelength	I_F = 20 mA	λ_p		610		nm
Angle of half intensity	I_F = 20 mA	φ		± 60		deg
Forward voltage	I_F = 20 mA	V_F		2.0	2.6	V
Reverse voltage	I_R = 10 µA	V_R	5			V
Junction capacitance	V_R = 0, f = 1 MHz	C_j		15		pF

[1] in one Packing Unit $I_{Vmax}/I_{Vmin} \leq 2.0$

Yellow

VLME230.

Parameter	Test condition	Symbol	Min	Typ.	Max	Unit
Luminous intensity [1]	I_F = 20 mA	I_V	56	112		mcd
Dominant wavelength	I_F = 20 mA	λ_d	581	588	594	nm
Peak wavelength	I_F = 20 mA	λ_p		590		nm
Angle of half intensity	I_F = 20 mA	φ		± 60		deg
Forward voltage	I_F = 20 mA	V_F		2.0	2.6	V
Reverse voltage	I_R = 10 µA	V_R	5			V
Junction capacitance	V_R = 0, f = 1 MHz	C_j		15		pF

[1] in one Packing Unit $I_{Vmax}/I_{Vmin} \leq 2.0$

Luminous Intensity Classification

Group	Light Intensity [mcd]		
Standard	Optional	Min	Max
N	1		
	2	35.5	45
P	1	45	56
	2	56	71
Q	1	71	90
	2	90	112
R	1	112	140
	2	140	180
S	1	180	224
	2	224	280
T	1	280	355
	2	355	450

Note:

Luminous intensity is tested at a current pulse duration of 25 ms and an accuracy of ± 11 %.

The above type Numbers represent the order groups which include only a few brightness groups. Only one group will be shipped on each reel (there will be no mixing of two groups on each reel). In order to ensure availability, single brightness groups will not be orderable.

In a similar manner for colors where wavelength groups are measured and binned, single wavelength groups will be shipped on any one reel.

In order to ensure availability, single wavelength groups will not be orderable.

Crossing Table

Vishay	Osram
VLME2300	LYM676
VLMF2300	LOM676
VLMK2300	LSM676

Color Classification

Group	Yellow		Softorange	
	Dom. Wavelength [nm]			
	Min.	Max.	Min.	Max.
1	581	584	598	601
2	583	586	600	603
3	585	588	602	605
4	587	590	604	607
5	589	592	606	609
6	591	594	608	611

Typical Characteristics (Tamb = 25 °C unless otherwise specified)

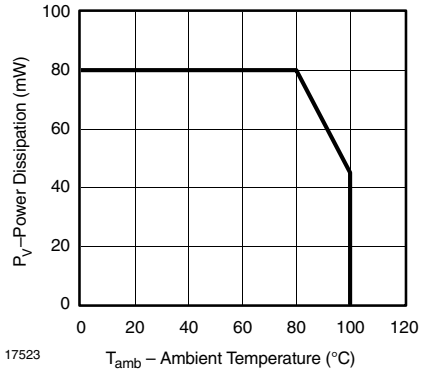


Figure 1. Power Dissipation vs. Ambient Temperature

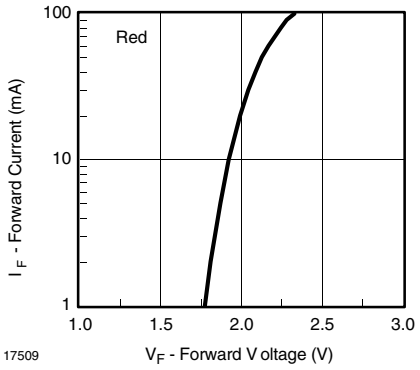


Figure 4. Forward Current vs. Forward Voltage

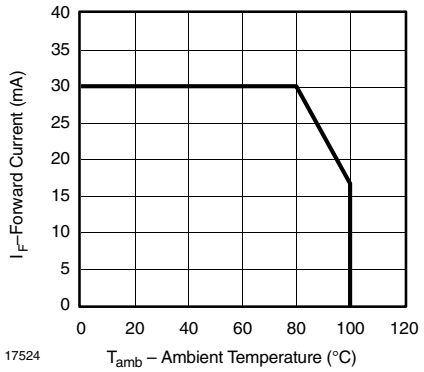


Figure 2. Forward Current vs. Ambient Temperature

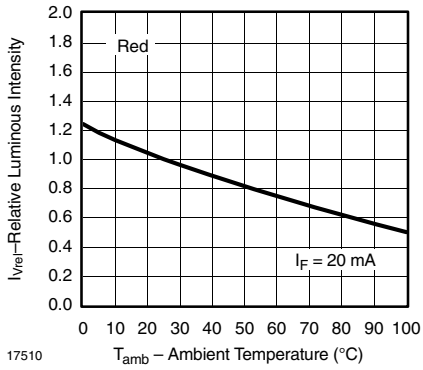


Figure 5. Rel. Luminous Intensity vs. Ambient Temperature

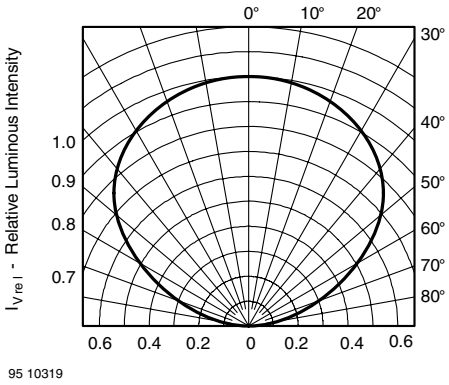


Figure 3. Rel. Luminous Intensity vs. Angular Displacement

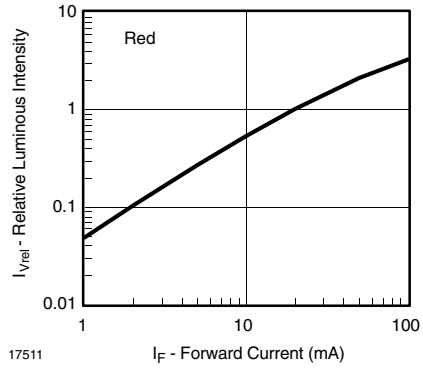


Figure 6. Relative Luminous Intensity vs. Forward Current

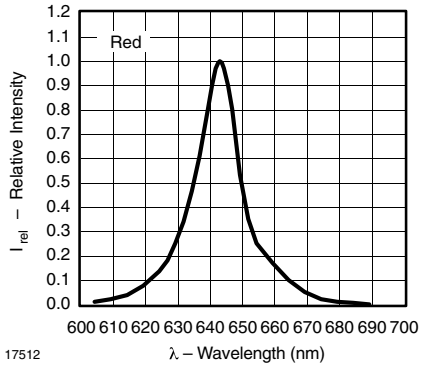


Figure 7. Relative Intensity vs. Wavelength

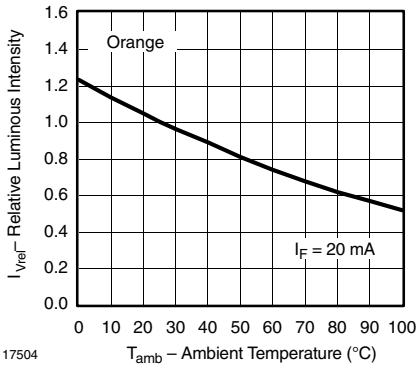


Figure 10. Rel. Luminous Intensity vs. Ambient Temperature

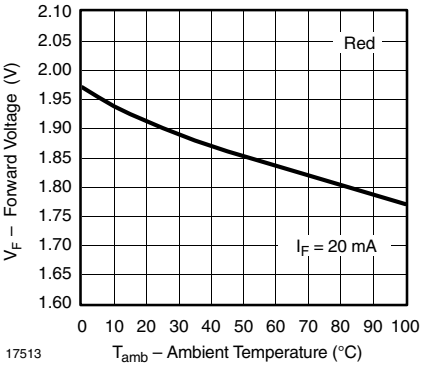


Figure 8. Forward Voltage vs. Ambient Temperature

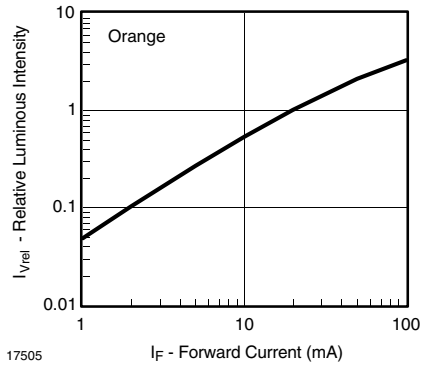


Figure 11. Relative Luminous Intensity vs. Forward Current

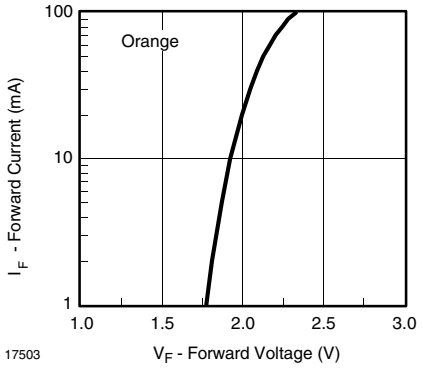


Figure 9. Forward Current vs. Forward Voltage

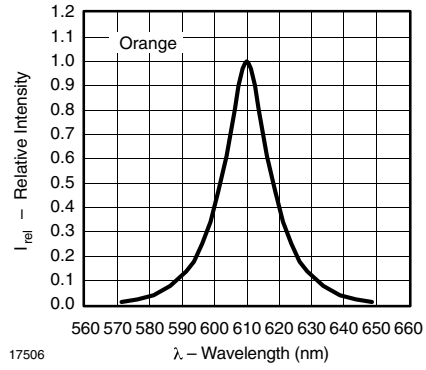


Figure 12. Relative Intensity vs. Wavelength

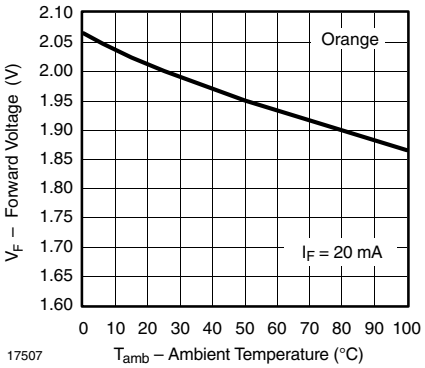


Figure 13. Forward Voltage vs. Ambient Temperature

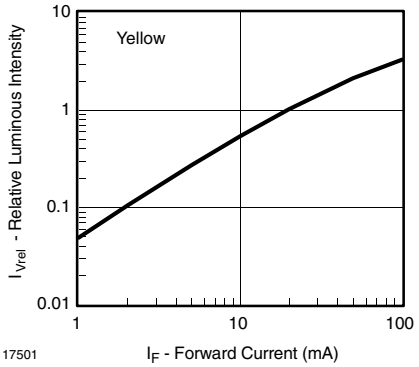


Figure 16. Relative Luminous Intensity vs. Forward Current

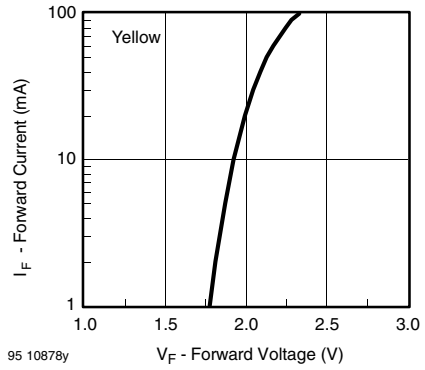


Figure 14. Forward Current vs. Forward Voltage

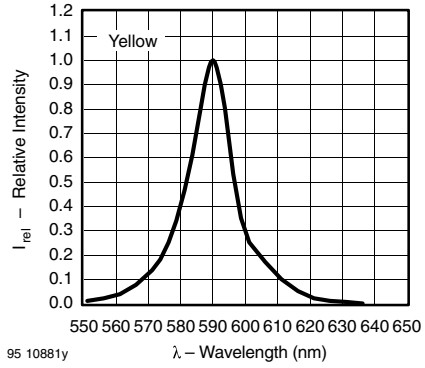


Figure 17. Relative Intensity vs. Wavelength

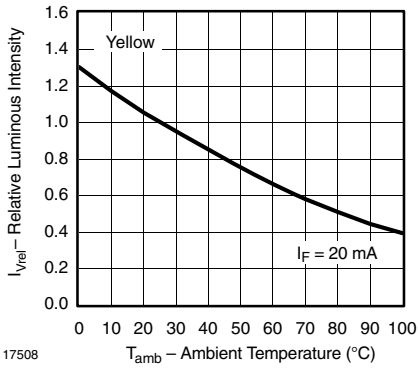


Figure 15. Rel. Luminous Intensity vs. Ambient Temperature

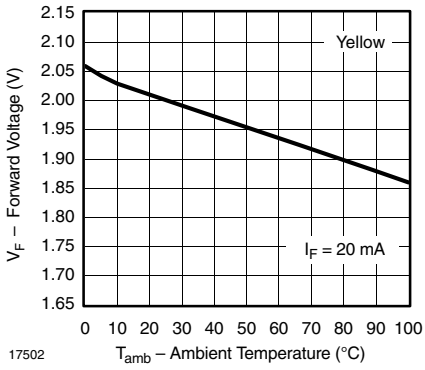
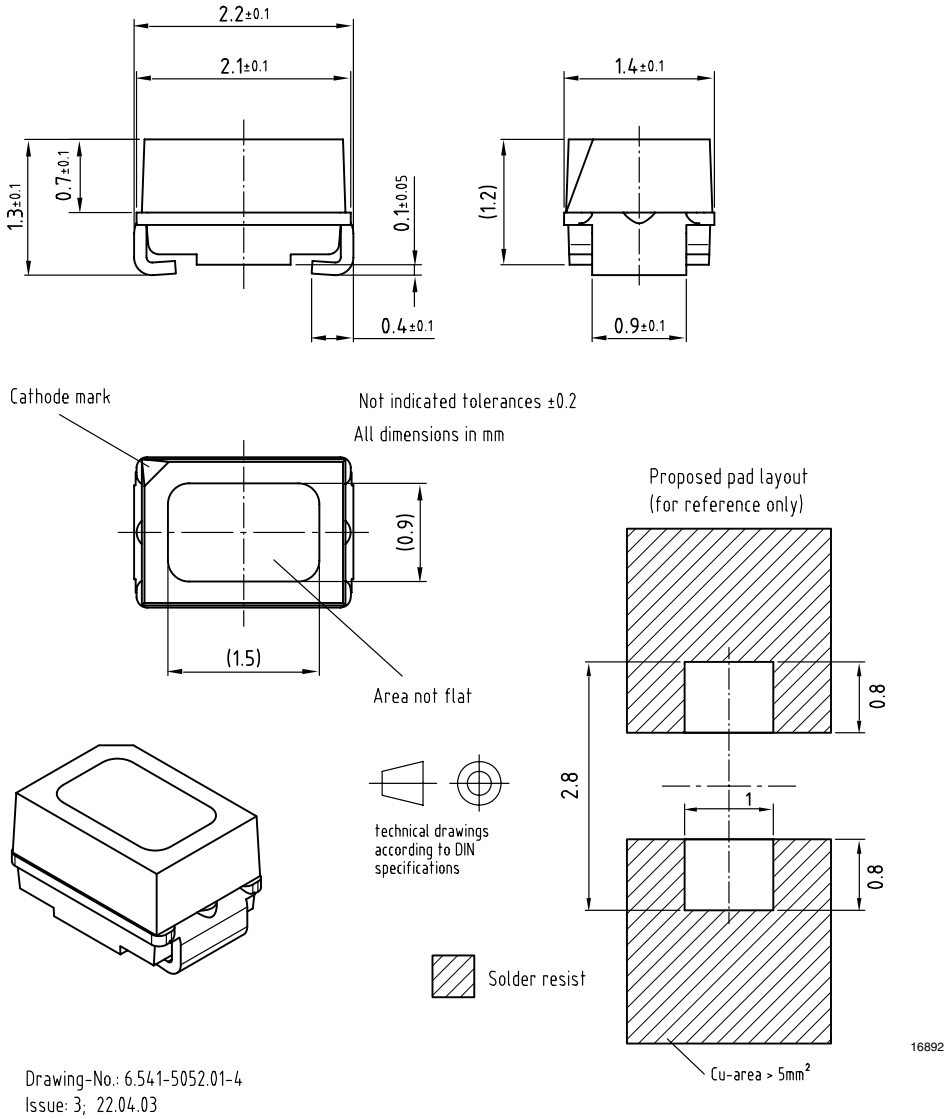


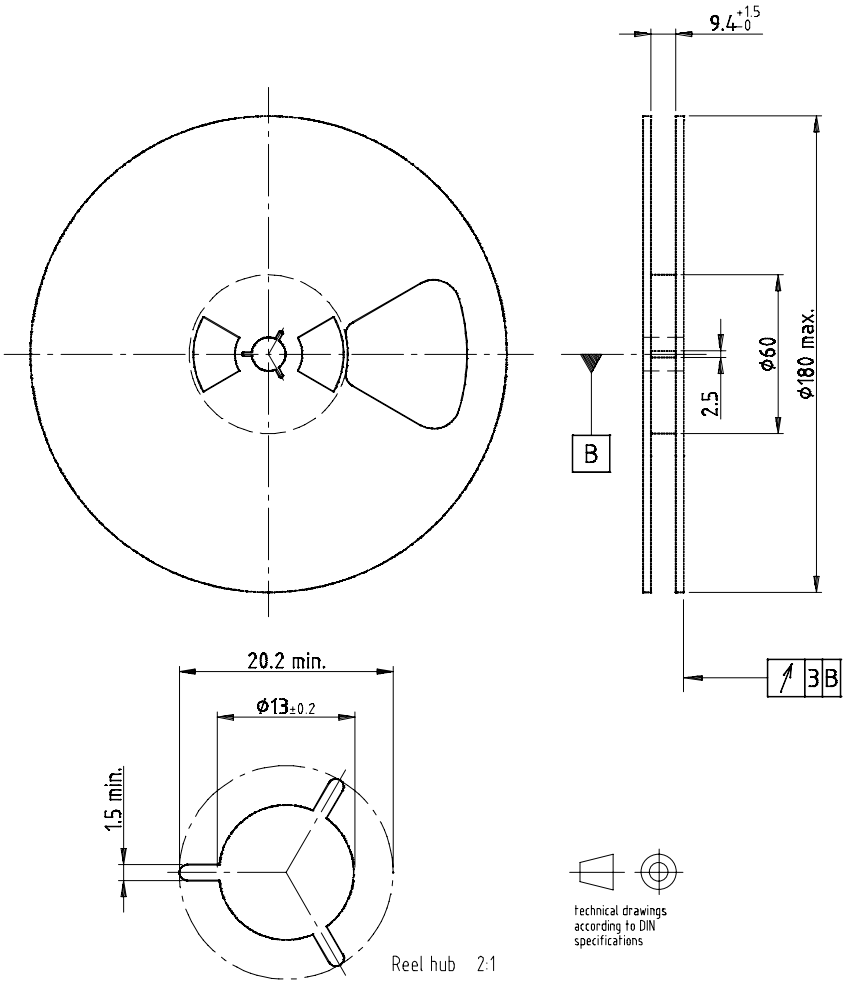
Figure 18. Forward Voltage vs. Ambient Temperature

Package Dimensions in mm



Drawing-No.: 6.541-5052.01-4
Issue: 3; 22.04.03

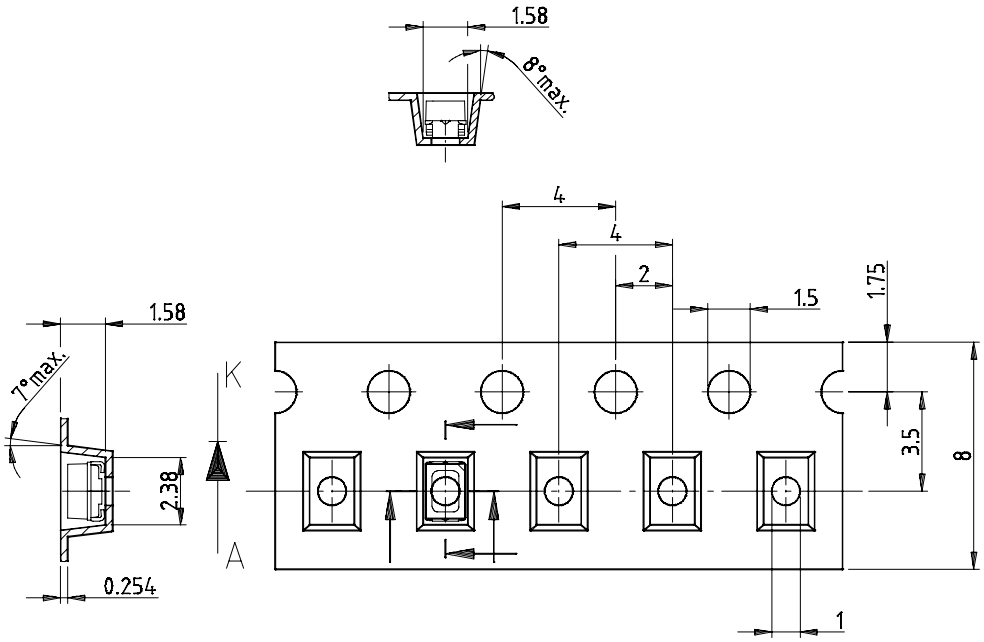
Reel Dimensions



Drawing-No.: 9.800-5051.V5-4
Issue: 1; 25.07.02

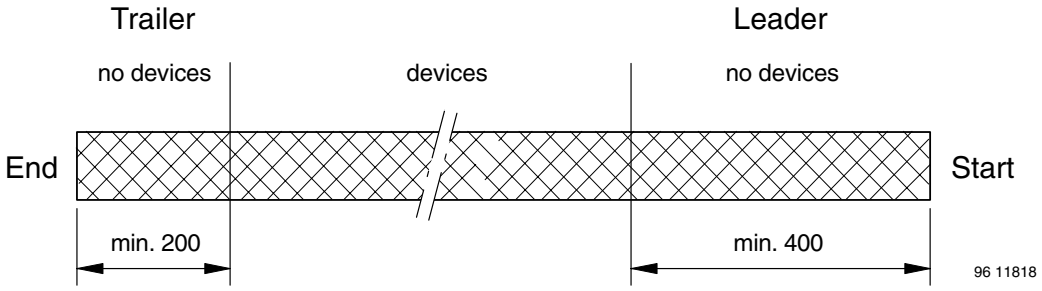
16938

Tape Dimensions



Drawing-No.: 9.700-5266.01-4
Issue: 1; 05.06.02

Leader and Trailer



GS08 = 3000 pcs

Cover Tape Peel Strength

According to DIN EN 60286-3
0.1 to 1.3 N
300 ± 10 mm/min
165° - 180° peel angle

Label

Standard bar code labels for finished goods

The standard bar code labels are product labels and used for identification of goods. The finished goods are packed in final packing area. The standard packing units are labeled with standard bar code labels before transported as finished goods to warehouses. The labels are on each packing unit and contain Vishay Semiconductor GmbH specific data.

Vishay Semiconductor GmbH standard bar code product label (finished goods)

Plain Writing	Abbreviation	Length
Item-Description	–	18
Item-Number	INO	8
Selection-Code	SEL	3
LOT -/ Serial-Number	BATCH	10
Data-Code	COD	3 (YWW)
Plant-Code	PTC	2
Quantity	QTY	8
Accepted by:	ACC	–
Packed by:	PCK	–
Mixed Code Indicator	MIXED CODE	–
Origin	xxxxxxx +	Company Logo

Long Bar Code Top	Type	Length
Item-Number	N	8
Plant-Code	N	2
Sequence-Number	X	3
Quantity	N	8
Total Length	–	21

Short Bar Code Bottom	Type	Length
Selection–Code	X	3
Data-Code	N	3
Batch-Number	X	10
Filter	–	1
Total Length	–	17

16942

Barcode-Product-Label

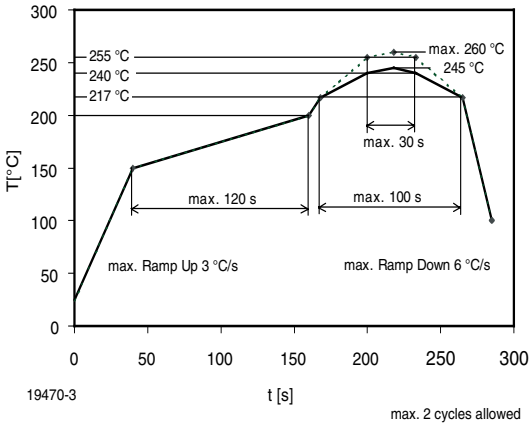


Figure 19. Vishay Leadfree Reflow Soldering Profile
(acc. to J-STD-020B)

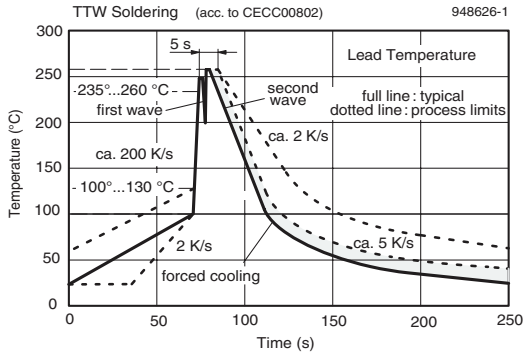
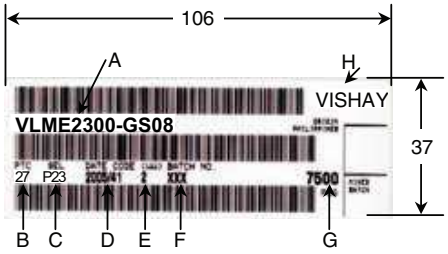


Figure 20. Double wave soldering of opto devices (all packages)

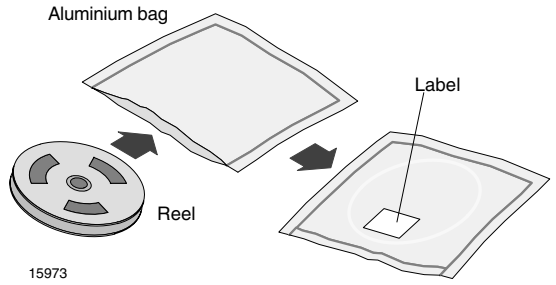
Barcode-Product-Label



A) Type of component
B) Manufacturing plant
C) SEL - Selection Code (Bin):
code for Luminous Intensity Group
D) Date Code year/week
E) Day Code (e.g. 2: Tuesday)
F) Batch No.
G) Total quantity
H) Company Code

Dry Packing

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



Final Packing

The sealed reel is packed into a cardboard box. A secondary cardboard box is used for shipping purposes.

Recommended Method of Storage

Dry box storage is recommended as soon as the aluminium bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity ≤ 60 % RH max.

After more than 672 hours under these conditions moisture content will be too high for reflow soldering.

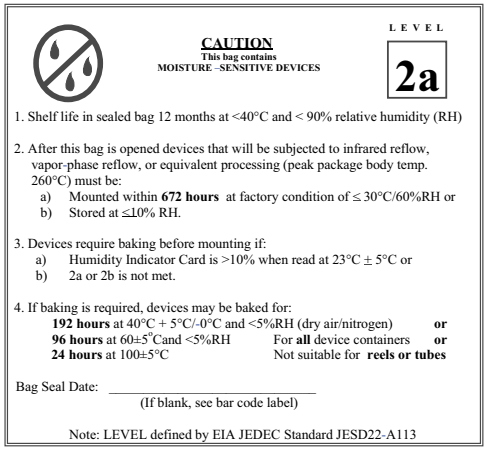
In case of moisture absorption, the devices will recover to the former condition by drying under the following condition:

192 hours at 40 °C + 5 °C/ - 0 °C and < 5 % RH (dry air/ nitrogen) or

96 hours at 60 °C + 5 °C and < 5 % RH for all device containers or

24 hours at 100 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC Standard JESD22-A112 Level 2a label is included on all dry bags.



Example of JESD22-A112 Level 2a label

ESD Precaution

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the Antistatic Shielding Bag. Electro-Static Sensitive Devices warning labels are on the packaging.

Vishay Semiconductors Standard Bar-Code Labels

The Vishay Semiconductors standard bar-code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.

Ozone Depleting Substances Policy Statement

It is the policy of Vishay Semiconductor GmbH to

1. Meet all present and future national and international statutory requirements.
2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

Vishay Semiconductor GmbH, P.O.B. 3535, D-74025 Heilbronn, Germany

Notice

Specifications of the products displayed herein are subject to change without notice. Vishay Intertechnology, Inc., or anyone on its behalf, assumes no responsibility or liability for any errors or inaccuracies.

Information contained herein is intended to provide a product description only. No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document. Except as provided in Vishay's terms and conditions of sale for such products, Vishay assumes no liability whatsoever, and disclaims any express or implied warranty, relating to sale and/or use of Vishay products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright, or other intellectual property right.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications. Customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Vishay for any damages resulting from such improper use or sale.